TOSHIBA TCD2556D

TOSHIBA CCD LINEAR IMAGE SENSOR CCD (Charge Coupled Device)

TCD2556D

The TCD2556D is a high sensitive and low dark current 5340 elements x 3 line CCD color image sensor which includes CCD drive circuit, clamp circuit and sample and

The sensor can be used for image scanner. The device contains a row of 5340 x 3 photodioeds, which provide a 24 lines/mm (600DPI) across a A4 size paper. The divice is operated by 5 V (Pulse), and 12 V power supply.

FEATURES

Number of Image Sensing Elements

: 5340 elements × 3 line

Image Sensing Element Size : $7 \mu m$ by $7 \mu m$ on $7 \mu m$ centers

Photo Sensing Region : High sensitive and low dark

current PN photodiode

Distance Between Photodiode Array : 28 μ m, 4 line

Clock : 2 phase (5 V)

Power Supply : 12 V Power supply voltage

: Sample and Hold Circuit, Clamp Circuit Internal Circuit

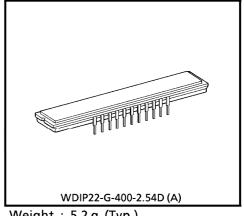
Package : 22 pin CERDIP package

Color Filter : Red, Green, Blue

MAXIMUM RATINGS (Note 1)

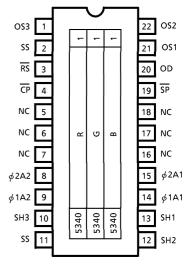
CHARACTERISTIC	SYMBOL	RATING	UNIT
Clock Pulse Voltage	Vφ		
Shift Pulse Voltage	V _{SH}		
Reset Pulse Voltage	VRS	-0.3~8	V
Clamp Pulse Voltage	VCP		
Sample and Hold Voltage	VSP		
Power Supply	V _{OD}	-0.3~15	V
Operating Temperature	T _{opr}	0~60	°C
Storage Temperature	T _{stg}	- 25~85	°C

(Note 1): All voltage are with respect to SS terminals (Ground).



Weight: 5.2 g (Typ.)

PIN CONNECTIONS



(TOP VIEW)

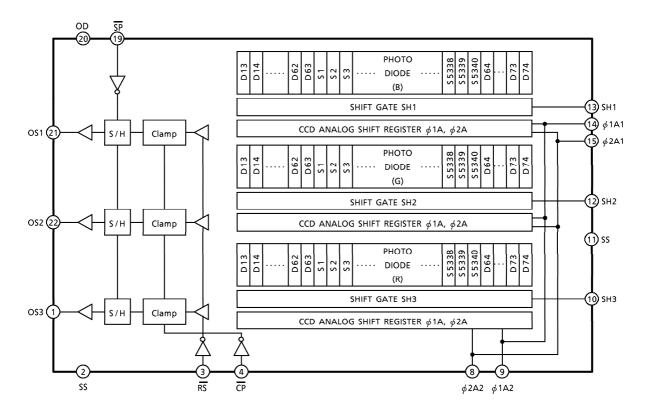
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TOSHIBA TCD2556D

CIRCUIT DIAGRAM



PIN NAMES

PIN No.	SYMBOL	NAME	PIN No.	SYMBOL	NAME
1	OS3	Signal Output 3 (Red)	12	SH2	Shift Gate 2
2	SS	Ground	13	SH1	Shift Gate 1
3	RS	Reset Gate	14	φ1A1	Clock 1 (Phase 1)
4	CP	Clamp Gate	15	φ 2A 1	Clock 1 (Phase 2)
5	NC	Non Connection	16	NC	Non Connection
6	NC	Non Connection	17	NC	Non Connection
7	NC	Non Connection	18	NC	Non Connection
8	φ2 A 2	Clock 2 (Phase 2)	19	SP	Sample and Hold Gate
9	φ1A2	Clock 2 (Phase 1)	20	OD	Power
10	SH3	Shift Gate 3	21	OS1	Signal Output 1 (Blue)
11	SS	Ground	22	OS2	Signal Output 2 (Green)

OPTICAL / ELECTRICAL CHARACTERISTICS

(Ta = 25°C, V_{OD} = V_{DD} = 12 V, V ϕ = V $\overline{\text{SH}}$ = V $\overline{\text{RS}}$ = V_{CP} = 5 V (PULSE), f ϕ = 1 MHz, f $\overline{\text{RS}}$ = 1 MHz, t_{INT} = 10 ms, LIGHT SOURCE = A LIGHT SOURCE + CM500S FILTER (t = 1 mm), LOAD RESISTANCE = 100 k Ω)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
	R _R	7.2	10.3	13.4		
Sensitivity	R _G	7.7	11.0	14.3	V / (lx·s)	(Note 2)
	R _B	4.2	6.0	7.8]	
Photo Posmonso Nen Uniformity	PRNU (1)	_	10	20	%	(Note 3)
Photo Response Non Uniformity	PRNU (3)	_	3	12	mV	(Note 4)
Image Lag	IL	_	1	_	%	(Note 5)
Saturation Output Voltage	V _{SAT}	2.0	2.5	_	V	(Note 6)
Saturation Exposure	SE	_	0.23	_	lx∙s	(Note 7)
Dark Signal Voltage	V _{DRK}	_	1.0	2.0	mV	(Note 8)
Dark Signal Non Uniformity	DSNU	_	2.0	5.0	mV	(Note 8)
DC Power Dissipation	PD	<u> </u>	300	400	mW	
Total Transfer Efficiency	TTE	92	_	_	%	
Output Impedance	ZO	<u> </u>	0.5	1.0	kΩ	
DC Signal Output Voltage	Vos	3.5	5.0	7.5	V	(Note 9)
Random Noise	N _D σ	l –	0.8	_	mV	(Note 10)
Reset Noise	V _{RSN}	l –	1.0	2.0	V	(Note 9)

- (Note 2): Responsivity is defined for each color of signal outputs average when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.
- (Note 3): PRNU (1) is defined for each color on a single chip by the expressions below when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

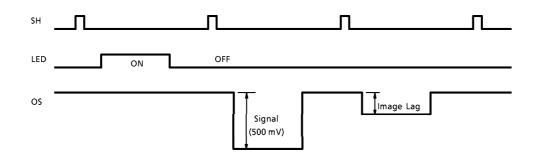
PRNU (1) =
$$\frac{\Delta \chi}{\overline{\chi}}$$
 × 100 (%)

When $\overline{\chi}$ is average of total signal output and $\Delta\chi$ is the maximum deviation from $\overline{\chi}$. The amount of incident light is shown below.

Red = $1/2 \cdot SE$ Green = $1/2 \cdot SE$ Bule = $1/4 \cdot SE$

(Note 4): PRNU (3) is defined as maximum voltage with next pixel, where measured 5% of SE (Typ.).

(Note 5): Image Lag is defined as follows.



(Note 6) : $V_{\mbox{SAT}}$ is defined as minimum saturation output of all effective pixels.

(Note 7): Definition of SE

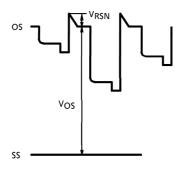
$$SE = \frac{V_{SAT}}{R_{G}} (Ix \cdot s)$$

(Note 8): V_{DRK} is defined as average dark signal voltage of all effective pixels.

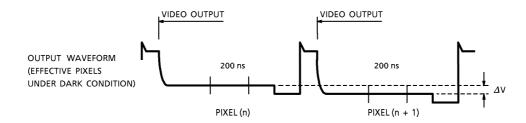
DSNU is defined as different voltage between V_{DRK} and V_{MDK} when V_{MDK} is maximum dark signal voltage.



(Note 9) : DC signal output voltage is defined as follows. Reset Noise Voltage is defined as follows.



(Note 10): Random noise is defined as the standard deviation (sigma) of the output level difference between two adjacent effective pixels under no illumination (i.e. dark conditions) calculated by the following procedure.



- 1) Two adjacent pixels (pixel n and n + 1) in one reading are fixed as measurement points.
- 2) Each of the output level at video output periods averaged over 200 ns period to get V(n) and V(n + 1).
- 3) V(n + 1) is subtracted from V(n) to get ΔV .

$$\Delta V = V(n) - V(n + 1)$$

4) The standard deviation of ΔV is calculated after procedure 2) and 3) are repeated 30 times (30 readings).

$$\overline{\Delta V} = \frac{1}{30} \sum_{i=1}^{30} |\Delta Vi| \qquad \sigma = \sqrt{\frac{1}{30} \sum_{i=1}^{30} (|\Delta Vi| - \overline{\Delta V})^2} \sigma$$

- 5) Procedure 2), 3) and 4) are repeated 10 times to get sigma value.
- 6) 10 sigma values are averaged.

$$\overline{\sigma} = \frac{1}{10} \sum_{i=1}^{10} \sigma_{i}$$

7) $\overline{\sigma}$ value calculated using the above procedure is observed $\sqrt{2}$ times larger than that measured relative to the ground level. So we specify random noise as follows.

$$ND \ \sigma = \frac{1}{\sqrt{2}} \, \overline{\sigma}$$

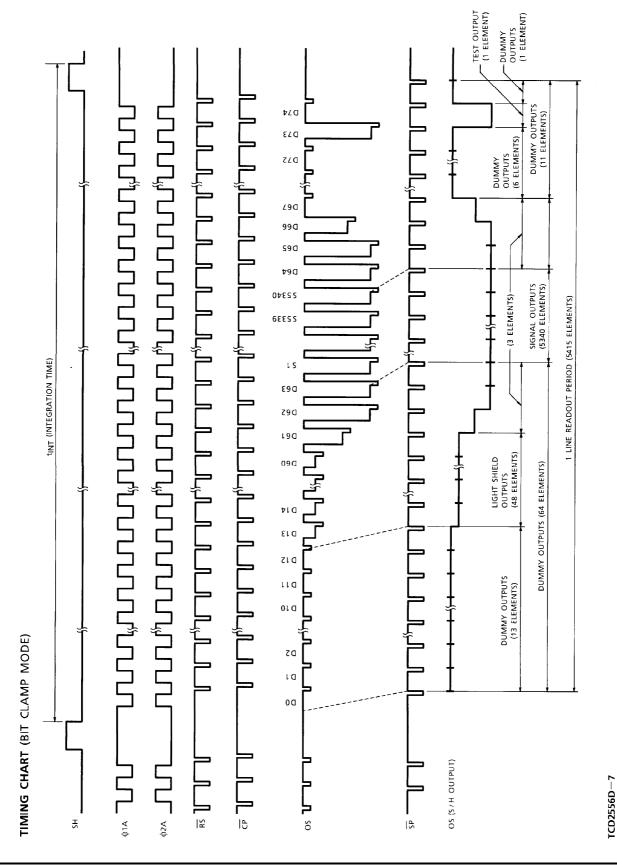
OPERATING CONDITION

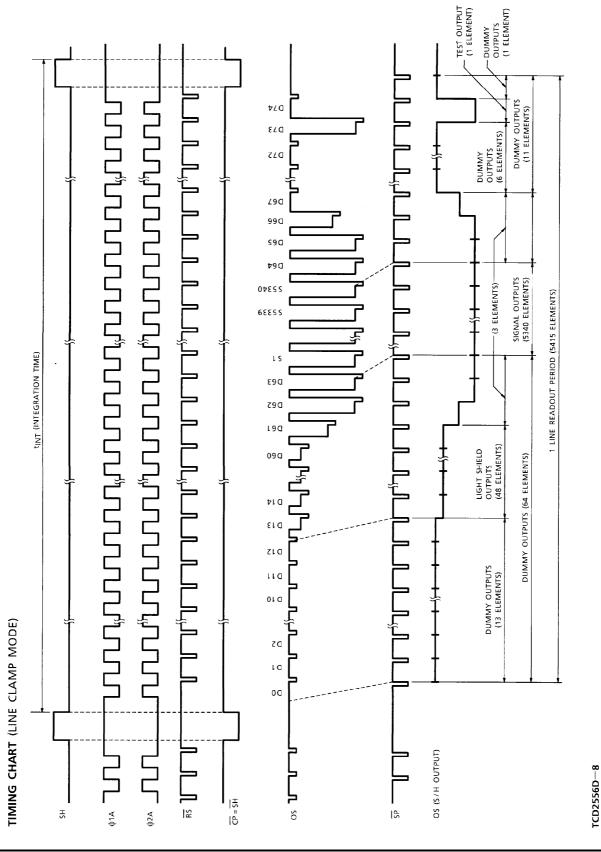
CHARACTERIST	ic	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Clask Dules Valtage	"H" Level	\/ / A	4.5	5.0	5.5	V	
Clock Pulse Voltage	"L" Level	V ϕ A	0.0	_	0.5	1 v	
Shift Dulca Valtage	"H" Level	\/	VφA"H" - 0.5	VφΑ"H"	V <i>∮</i> A"H"	V	(Note 11)
Shift Pulse Voltage	"L" Level	V _{SH}	0.0		0.5]	(Note 11)
Reset Pulse Voltage	"H" Level	\/ =	4.5	5.0	5.5	V	
Reset Puise Voitage	"L" Level	V RS	0.0		0.5] V	
Sample and Hold Pulse	"H" Level	V an	4.5	5.0	5.5	V	(Note 12)
Voltage	"L" Level	VSP	0.0		0.5] '	(Note 12)
Clamp Pulse Voltage	"H" Level	V==	4.5	5.0	5.5	V	
Clamp Pulse Voltage	"L" Level	VCP	0.0	_	0.5] V	
Power Supply Voltage		V _{OD}	11.4	12.0	13.0	V	

(Note 11) : $V\phi A''H''$ means the high level voltage of $V\phi A$ when SH pulse is high level. (Note 12) : Supply "L" Level to \overline{SP} terminal when sample and hold circuitry is not used.

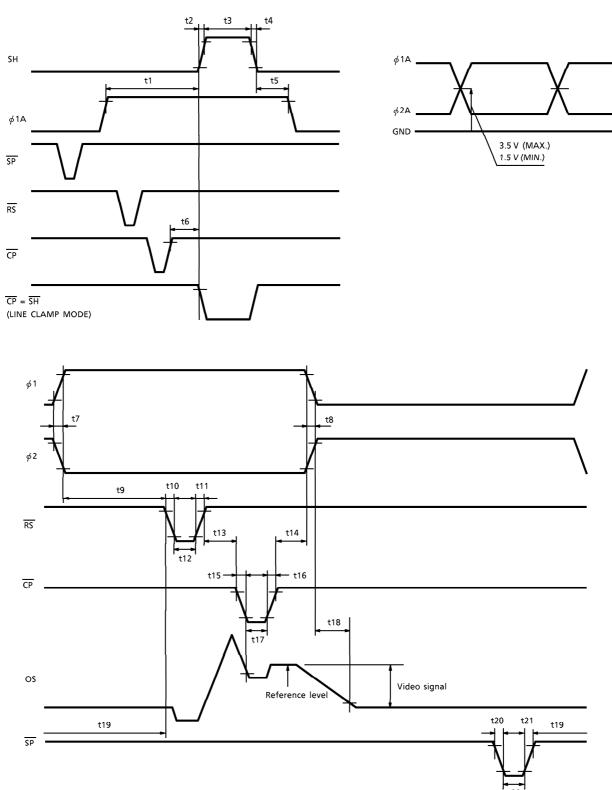
CLOCK CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Clock Pulse Frequency	fφ	0.3	1.0	3.0	MHz
Reset Pulse Frequency	fRS	0.3	1.0	3.0	MHz
Clamp Pulse Frequency	fCP	0.3	1.0	3.0	MHz
Sample and Hold Pulse Frequency	f <u>SP</u>	0.3	1.0	3.0	MHz
Clock Capacitance	$C\phi$	_	300	400	pF
Shift Gate Capacitance	CSH	_	50	100	pF
Reset Gate Capacitance	CRS	_	20	30	pF
Sample and Hold Gate Capacitance	CSP	_	20	30	pF
Clamp Gate Capacitance	CCP	_	20	30	pF





TIMING REQUIREMENTS



TIMING REQUIREMENTS

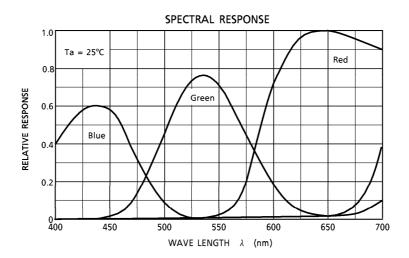
CHARACTERISTIC	SYMBOL	MIN.	TYP. (Note 13)	MAX.	UNIT
Dulas Timing of Cl. and 71	t1	120	1000	_	
Pulse Timing of SH and ϕ 1	t5	800	1000	_	ns
SH Pulse Rise Time, Fall Time	t2, t4	0	50	ns	
SH Pulse Width	t3	3000	5000	_	ns
Pulse Timing of SH and CP	t6	200	500	_	ns
ϕ 1, ϕ 2 Pulse Rise Time, Fall Time	t7, t8	0	50	_	ns
Pulse Timing of ϕA and RS	t9	20	40	_	ns
RS Pulse Rise Time, Fall Time	t10, t11	0	20	_	ns
RS Pulse Width	t12	30	80	_	ns
Pulse Timing of RS and CP	t13	40	80	_	ns
Pulse Timing of ϕ 1A, ϕ 2A and CP	t14	0	20	_	ns
CP Pulse Rise Time, Fall Time	t15, t16	0	20	_	ns
CP Pulse Width	t17	40	80	_	ns
Video Data Delay Time (Note 14)	t18	_	80	_	ns
SP Pulse Rise Time, Fall Time	t20, t21	0	20	_	ns
SP Pulse Width	t22	50	100	_	ns
Pulse Timing of ϕA and SP	t19	0	20		ns

(Note 13) : TYP. is the case of fRS = 1.0 MHz (Note 14) : Load resistance is 100 $k\Omega$

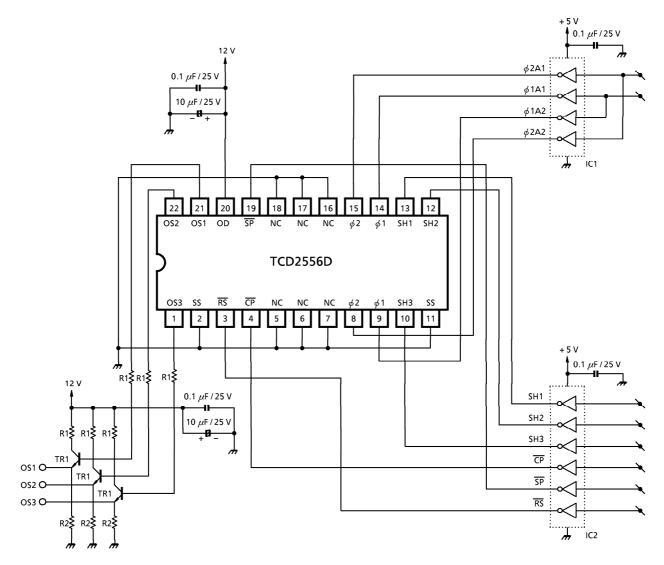
APPLICATION NOTE MODE SELECT

Sample and Hold	ON	OFF	
Sample and Hold	SP Pulse	SP = Low	
Clamp Mode	Bit Clamp	Line Clamp	
Clamp Mode	CP Pulse	$CP = \overline{SH}$	

TYPICAL SPECTRAL RESPONSE



TYPICAL DRIVE CIRCUIT



 $\begin{array}{lll} \text{IC1, 2} & : \ \text{TC74HC04AP} \\ \text{TR1} & : \ \text{2SC1815-Y} \\ \text{R1} & : \ \text{150} \ \Omega \\ \text{R2} & : \ \text{1500} \ \Omega \\ \end{array}$

CAUTION

1. Window Glass

The dust and stain on the glass window of the package degrade optical performance of CCD sensor.

Keep the glass window clean by saturating a cotton swab in alcohol and lightly wiping the surface, and allow the glass to dry, by blowing with filtered dry N₂.

Care should be taken to avoid mechanical or thermal shock because the glass window is easily to damage.

2. Electrostatic Breakdown

Store in shorting clip or in conductive foam to avoid electrostatic breakdown.

This device has some weakly terminals for static electricity. Therefor, please pay attention to treat this device.

CCD Image Sensor is protected against static electricity, but inferior puncture mode device due to static electricity is sometimes detected. In handing the device, it is necessary to execute the following static electricity preventive measures, in order to prevent the trouble rate increase of the manufacturing system due to static electricity.

- a. Prevent the generation of static electricity due to friction by making the work with bare hands or by putting on cotton gloves and non-charging working clothes.
- b. Discharge the static electricity by providing earth plate or earth wire on the floor, door or stand of the work room.
- c. Ground the tools such as soldering iron, radio cutting pliers of or pincer.
 It is not necessarily required to execute all precaution items for static electricity.
 It is all right to mitigate the precautions by confirming that the trouble rate within the prescribed range.

3. Incident Light

CCD sensor is sensitive to infrared light.

Note that infrared light component degrades resolution and PRNU of CCD sensor.

4. Lead Frame Forming

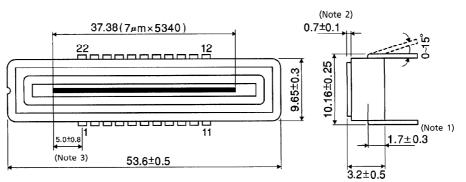
Since this package is not strong against mechanical stress, you should not reform the lead frame.

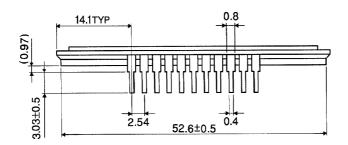
We recommend to use a IC-inserter when you assemble to PCB.

Unit: mm

OUTLINE DRAWING

WDIP22-G-400-2.54D (A)





(Note 1): TOP OF CHIP TO BOTTOM OF PACKAGE.

(Note 2): GLASS THICKNESS (n = 1.5)

(Note 3): No.1 SENSOR ELEMENT (S1) TO EDGE OF No.1 PIN.

Weight: 5.2 g (Typ.)